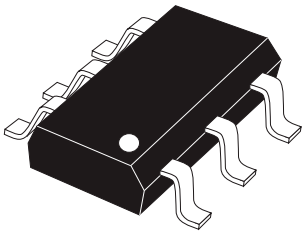
DSL03

Low capacitance TVS for high speed lines such as xDSL

Datasheet - production data



SOT23-6L

Features

- High surge capability to comply with GR-1089 and ITU-T K20/21
- Keeps its peak power capability up to T_j max
- Voltages: 10, 22 and 24 V
- Low capacitance device: C_{typ} = 0.5 pF
- RoHS package
- Low leakage current: 0.2 µA at 25 °C

Complies with the following standards

- Telcordia GR-1089
  - 2.5 kV 2/10 µs - 500 A 2/10 µs
  - AC power fault tests
- ITU-T K20/21/45
  - 6 kV 10/700 µs - 150 A 5/310 µs
  - power induction tests
  - power contact tests
- IEC 61000-4-2, level 4
  - 15 kV (air discharge)
  - 8 kV (contact discharge
- IEC 61000-4-5, level 2
  - ±1 kV, 42 Ω
- MIL STD 883G-Method 3015-7: Class 3
  - 8 kV (human body model)

Description

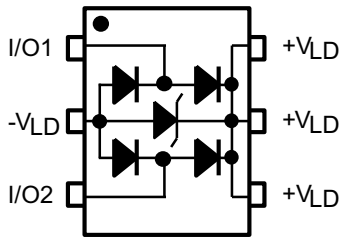
DSL03 is designed to protect DSL line drivers against surges defined in worldwide telecommunication standards. This device protects line drivers of various systems such as ADSL and VDSL. The low capacitance makes it suitable from ADSL to VDSL2 data rates.

DSL03 is able to survive severe conditions even when used with downgraded or oscillating gas tube.

DSL03 is also suitable to be used on other lines when IEC61000-4-5 surge capability is required.

DSL03 is packaged in a SOT23-6L.

Figure 1. Functional diagram



This is information on a product in full production. www.st.com

1 Characteristics

Table 1. Absolute ratings (T_{amb} = 25 °C)

Symbol	Parameter		Value	Unit
V_{pp}	Peak pulse voltage	IEC 61000-4-5 contact discharge	30	kV
I_{pp}	Peak pulse current	8/20µs	16	A
T_{stg} T_j	Storage temperature range Operating junction temperature range		-55 to 150 -40 to 125	°C °C
T_L	Maximum temperature for soldering during 10s		260	°C

Table 2. Electrical characteristics (T_{amb} = 25 °C)

Order code	I_{RM} @ V_{RM} I/O to I/O		V_{BR} @ I_{BR} I/O to I/O		V_{CL} @ I_{PP} 8/20 µs I/O to I/O		C I/O to I/O	C I/O to I/O	ΔC I/O to I/O
	Max. µA	V	Min V	mA	Max. V	A	typ. (1) pF	max.(1) pF	typ.(2) pF
DSL03-010SC6	0.2	10	10.5	1	29	16	0.5	3	0.2
DSL03-022SC6	0.2	22	25	1	52	16	0.5	3	0.2
DSL03-024SC6	0.2	24	28	1	55	16	0.5	3	0.2

1. Test conditions: V_R = 2 V bias, V_{RMS} = 1 V, F = 1 MHz
2. Measured between 1 V and V_{RM}

Figure 2. Peak pulse power dissipation versus initial junction temperature (typical values, 8/20µs)

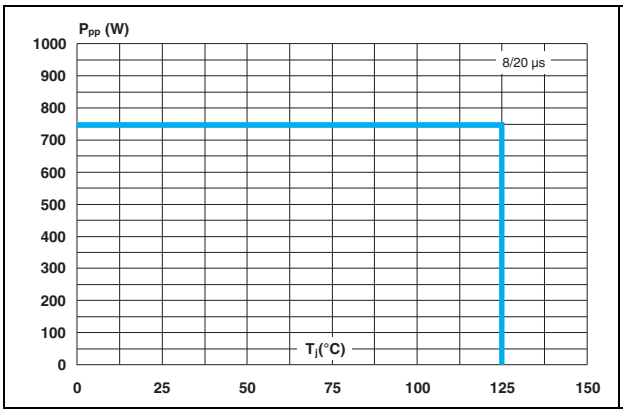


Figure 3. Leakage current versus junction temperature (typical values)

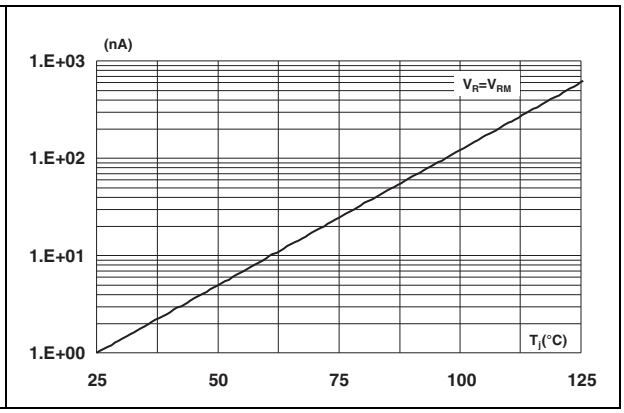


Figure 4. Junction capacitance versus reverse voltage applied (typical values)

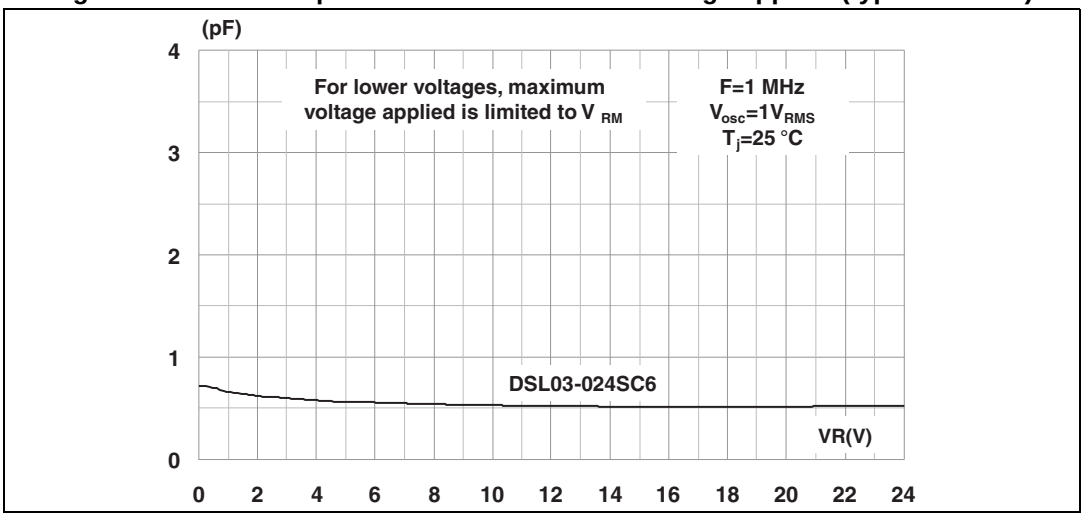


Figure 5. VDSL2 class AB modem connection

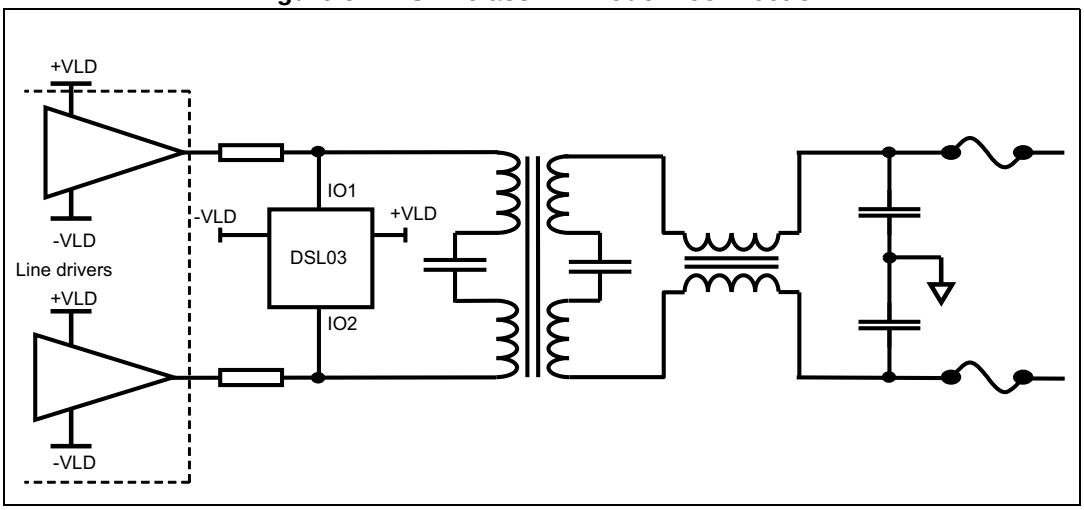
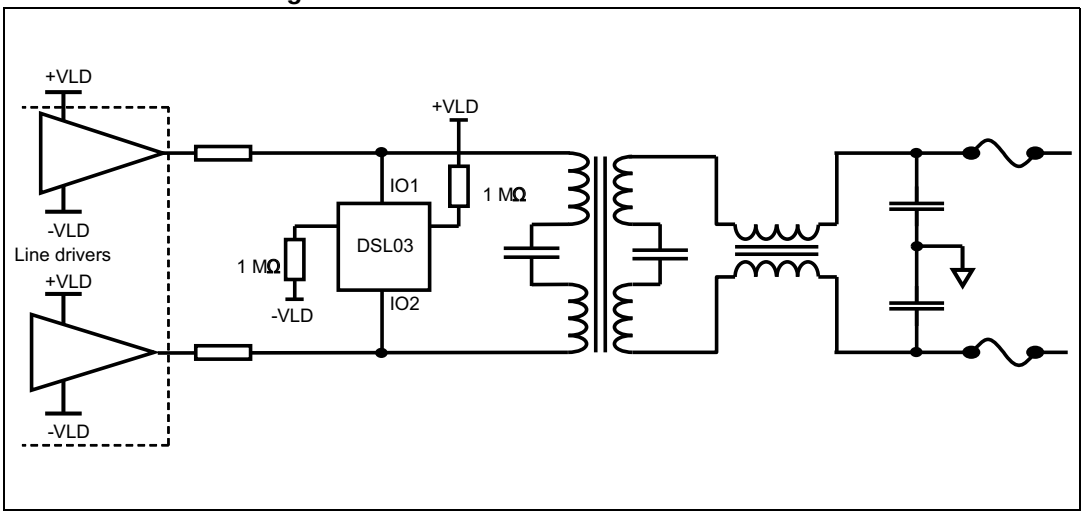


Figure 6. VDSL2 class H modem connection



2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK® is an ST trademark.

Figure 7. SOT23-6L dimension definitions

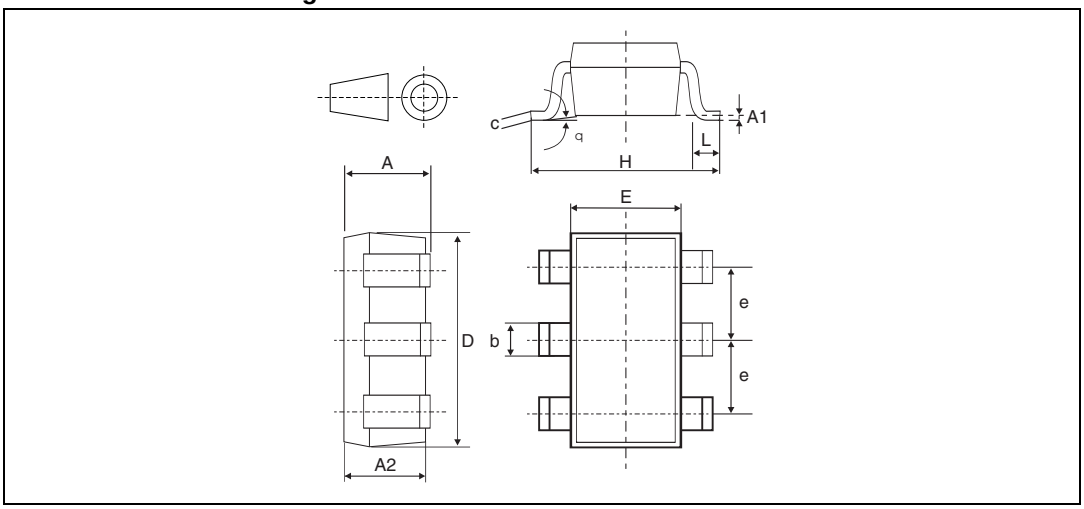


Table 3. SOT23-6L dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.		Max.	Min.		Max.
A	0.90		1.45	0.035		0.057
A1	0		0.10	0		0.004
A2	0.90		1.30	0.035		0.051
b	0.35		0.50	0.014		0.020
c	0.09		0.20	0.004		0.008
D	2.80		3.05	0.11		0.118
E	1.50		1.75	0.059		0.069
e		0.95			0.037	
H	2.60		3.00	0.102		0.118
L	0.10		0.60	0.004		0.024
θ	0°		10°	0°		10°

Figure 8. Footprint recommendations dimensions in mm (inches)

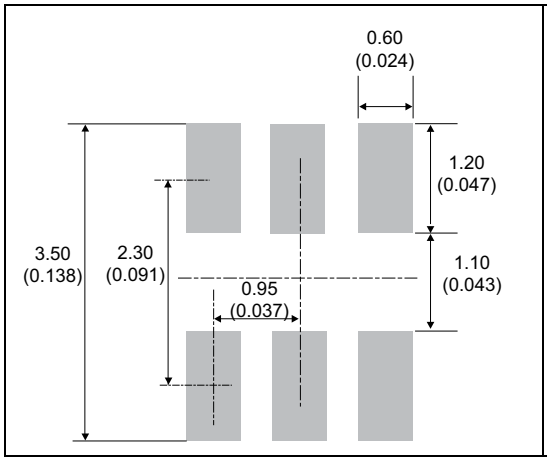
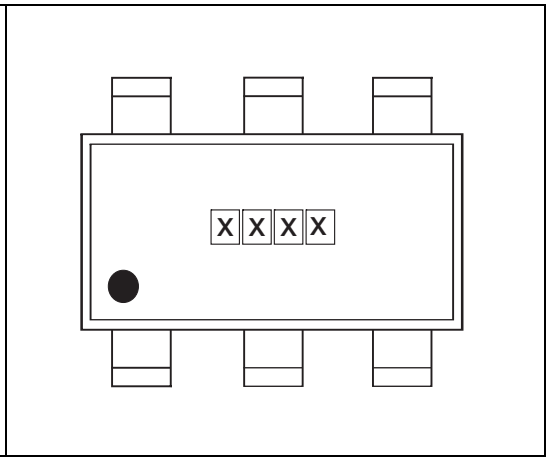


Figure 9. Marking layout



3 Ordering information

Figure 10. Ordering information scheme

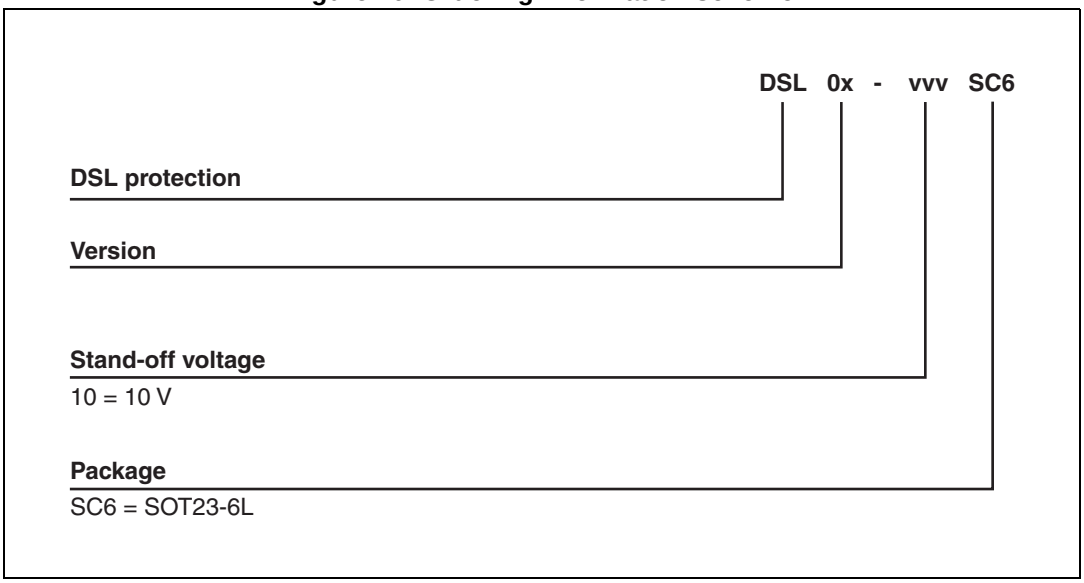


Table 4. Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
DSL03-010SC6	ST10	SOT23-6L	17.3 mg	3000	Tape and reel
DSL03-022SC6	ST22				
DSL03-024SC6	ST24				

4 Revision history

Table 5. Document revision history

Date	Revision	Changes
07-Feb-2014	1	Initial release
03-Feb-2015	2	Updated *Features* and *Description*. Added *Figure 5* and *Figure 6*.

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